506253329 09/15/2020

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
PING-WEN CHEN	08/18/2020
MIN-TSE LEE	08/18/2020
SHENG-YEN CHENG	08/18/2020
YUEH-HUNG CHUNG	08/18/2020
YUEH-CHI WU	08/18/2020
SHU-WEN LIAO	08/18/2020
TI-KUEI YU	08/18/2020
YA-LING HSU	08/18/2020
CHEN-HSIEN LIAO	08/18/2020

RECEIVING PARTY DATA

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State/Country:	TAIWAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17017706

CORRESPONDENCE DATA

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	098964-US-PA
NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/

PATENT 3329 REEL: 053779 FRAME: 0984

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DATE SIGNED:	09/15/2020
Total Attachments: 4	
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PATENT REEL: 053779 FRAME: 0985

DECLARATION AND ASSIGNMENT

FOR UTILITY OR DESIGN PATENT APPLICATION

Declaration Submitted With Initial Filing		
R		
Declaration Submitted After Initial Filing (surcharge 37 CFR 1.16(f) required) (Little of the Invention)		
PIXEL ARRAY SUBSTRATE		
s a below named inventor (hereinafter designated as the undersigned), I hereby		
eclare that:		
his declaration is directed to:		
The attached application,		
R		
United States Application Number or PCT International application number		
Filed on		

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

The undersigned hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

AU1912011 098964-US-PA

DECLARATION AND ASSIGNMENT

FOR UTILITY OR DESIGN PATENT APPLICATION

WHEREAS, the undersigned has invented certain new and useful improvements described in the application identified.

WHEREAS, 1. Au Optronics Corporation

of No. 1, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan,

R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring the undersigned's interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by the undersigned, the undersigned has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said the undersigned had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

The undersigned further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

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DECLARATION AND ASSIGNMENT

FOR UTILITY OR DESIGN PATENT APPLICATION

Signature: Ping Wen Chen Date: >020.08.18
Legal Name of Sole or First Inventor: Ping-Wen Chen
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Signature: Sheng Yen Cheng Date: 2020 .08.18
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Signature: Juh Jun (hy Date: 2020. ch 18
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RECORDED: 09/15/2020

DECLARATION AND ASSIGNMENT

FOR UTILITY OR DESIGN PATENT APPLICATION

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